

### 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 2. Features and benefits

- Low threshold voltage
- Trench MOSFET technology
- MLPAK33 package (3.3 x 3.3 mm footprint)

### 3. Applications

- High-side load switch
- Battery management
- DC-to-DC conversion
- Switching circuits

## 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-20	V
V <sub>GS</sub>	gate-source voltage			-12	-	12	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-	-20.2	А
Static chara	cteristics						
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = -4.5 V; I <sub>D</sub> = -12.3 A; T <sub>j</sub> = 25 °C		-	6.6	8.3	mΩ
		V <sub>GS</sub> = -2.5 V; I <sub>D</sub> = -9.7 A; T <sub>j</sub> = 25 °C		-	9.6	13.3	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



# 5. Pinning information

Table 2	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	S	source	1 2 3 4					
2	S	source	_ف_ف_ف_					
3	S	source						
4	G	gate	Ł ¥					
5	D	drain						
6	D	drain	Цеееи	S 017aaa257				
7	D	drain						
8	D	drain	MLPAK33 (SOT8002-1)					

# 6. Ordering information

Table 3. Ordering information           Type number			
	Name	Description	Version
PXP8R3-20QX		plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1

# 7. Marking

Table 4. Marking codes	
Type number	Marking code
PXP8R3-20QX	9AW

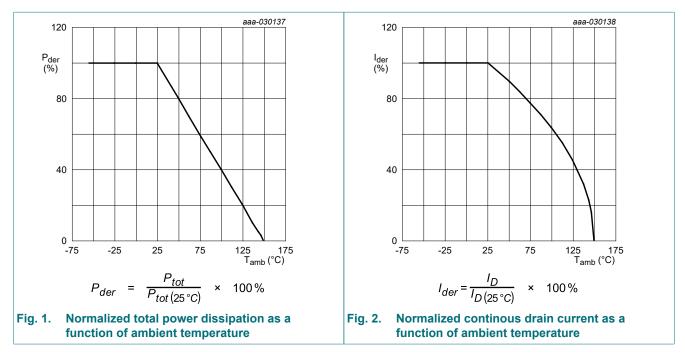
## 8. Limiting values

#### Table 5. Limiting values

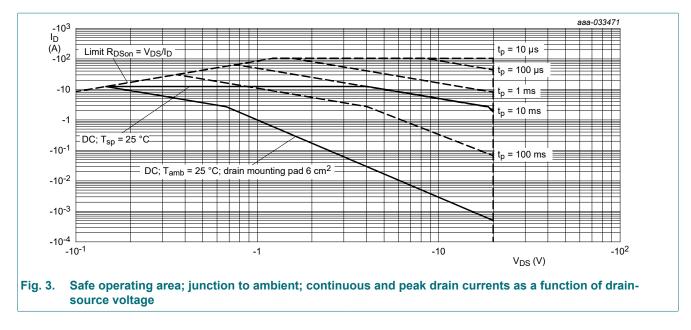
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-20	V
V <sub>GS</sub>	gate-source voltage	_		-12	12	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-20.2	А
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C	[1]	-	-12.4	А
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 100 °C	[1]	-	-7.8	А
		V <sub>GS</sub> = -4.5 V; T <sub>sp</sub> = 25 °C		-	-65.1	А
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-102.8	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	4.8	W
		T <sub>amb</sub> = 25 °C	[1]	-	1.8	W
		T <sub>sp</sub> = 25 °C		-	50	W
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C
Source-drai	n diode					
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-1.7	A
	Letter and the second se					-

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



#### 20 V, P-channel Trench MOSFET

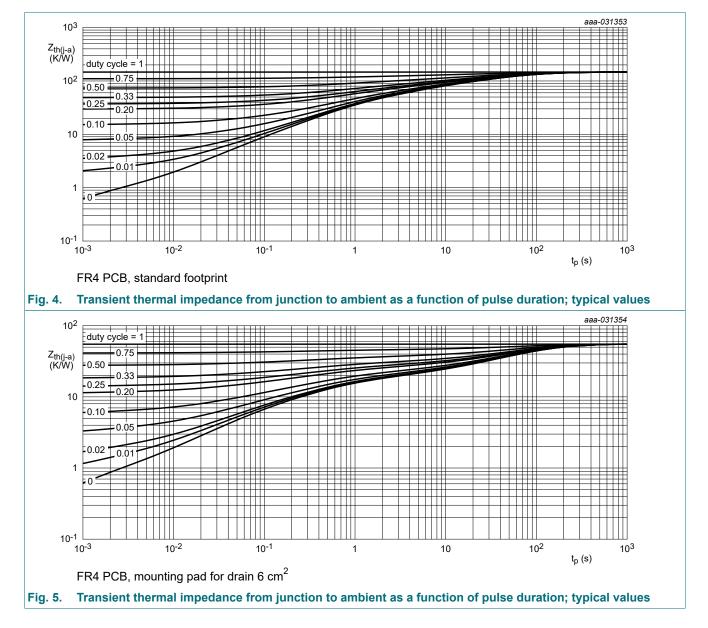


## 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1]	-	145	185	K/W
			[2]	-	55	70	K/W
		in free air; t ≤ 5 s	[2]	-	21	26	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	1.5	2.5	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

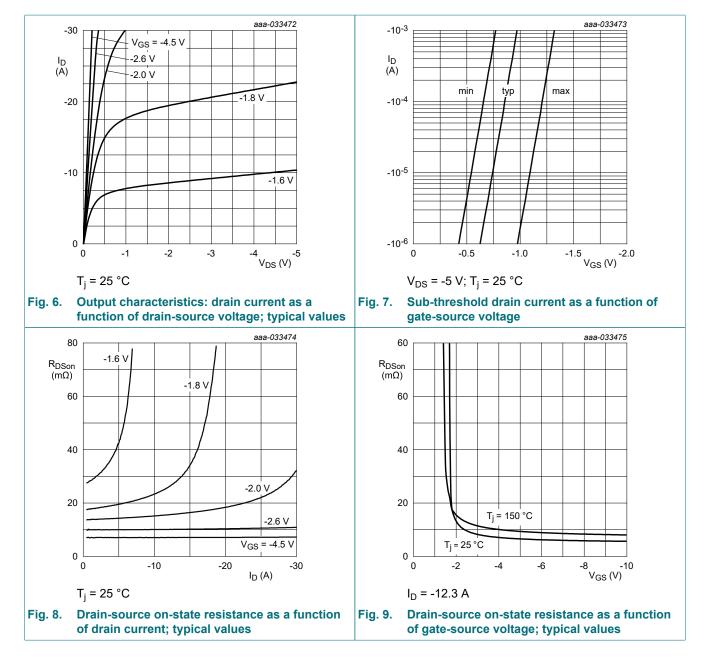
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



# **10. Characteristics**

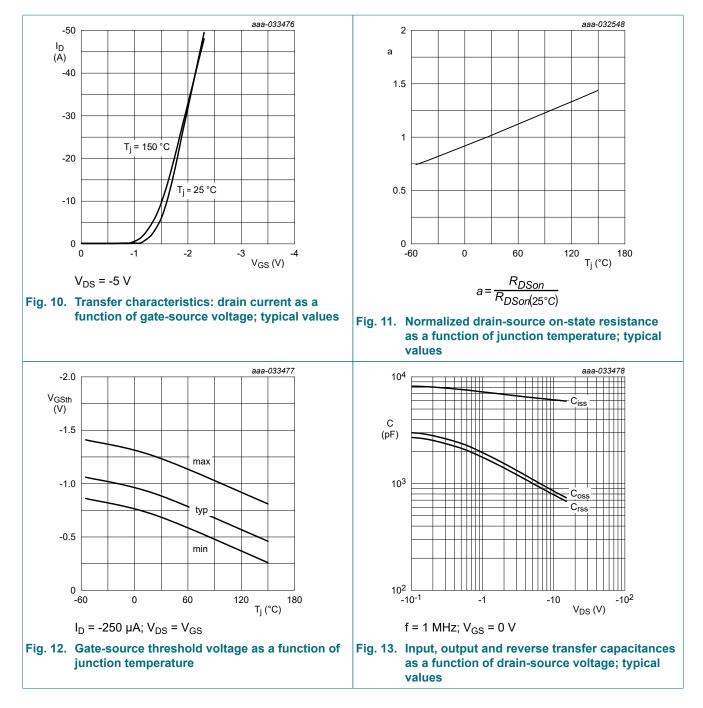
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	I <sub>D</sub> = -250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-20	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	I <sub>D</sub> = -250 μA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 25 °C	-0.7	-0.9	-1.25	V
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = -20 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-1	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = -12 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-0.1	μA
		V <sub>GS</sub> = 12 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	0.1	μA
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -12.3 A; T <sub>j</sub> = 25 °C	-	6.6	8.3	mΩ
	resistance	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -12.3 A; T <sub>j</sub> = 150 °C	-	9.4	11.8	mΩ
		V <sub>GS</sub> = -2.5 V; I <sub>D</sub> = -9.7 A; T <sub>j</sub> = 25 °C	-	9.6	13.3	mΩ
9fs	forward transconductance	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -12.3 A; T <sub>j</sub> = 25 °C	-	43	-	S
R <sub>G</sub>	gate resistance	f = 1 MHz	-	2.4	-	Ω
Dynamic ch	aracteristics					
Q <sub>G(tot)</sub>	total gate charge	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -12.3 A; V <sub>GS</sub> = -4.5 V;	-	61.2	91.8	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	10	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge		-	5.1	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		-	4.9	-	nC
Q <sub>GD</sub>	gate-drain charge	1	-	18.4	-	nC
V <sub>GSpl</sub>	gate-source plateau voltage	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -12.3 A; T <sub>j</sub> = 25 °C	-	-1.7	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = -10 V; f = 1 MHz; V <sub>GS</sub> = 0 V;	-	6200	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	840	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	780	-	pF
d(on)	turn-on delay time	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -9.7 A; V <sub>GS</sub> = -4.5 V;	-	14	-	ns
t <sub>r</sub>	rise time	R <sub>G(ext)</sub> = 5 Ω; T <sub>j</sub> = 25 °C	-	42	-	ns
t <sub>d(off)</sub>	turn-off delay time	1	-	101	-	ns
t <sub>f</sub>	fall time	1 -	-	62	-	ns
Source-drai	n diode		I		1	
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = -1.7 A; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	-0.7	-1.2	V
	reverse recovery time	I <sub>S</sub> = -1.7 A; dI <sub>S</sub> /dt = 100 A/µs;	-	38	-	ns
Q <sub>r</sub>	recovered charge	V <sub>GS</sub> = -4.5 V; V <sub>DS</sub> = -10 V; T <sub>j</sub> = 25 °C	-	26	-	nC
t <sub>a</sub>	reverse recovery rise time		-	13	-	ns
t <sub>b</sub>	reverse recovery fall time		-	25	-	ns

#### 20 V, P-channel Trench MOSFET



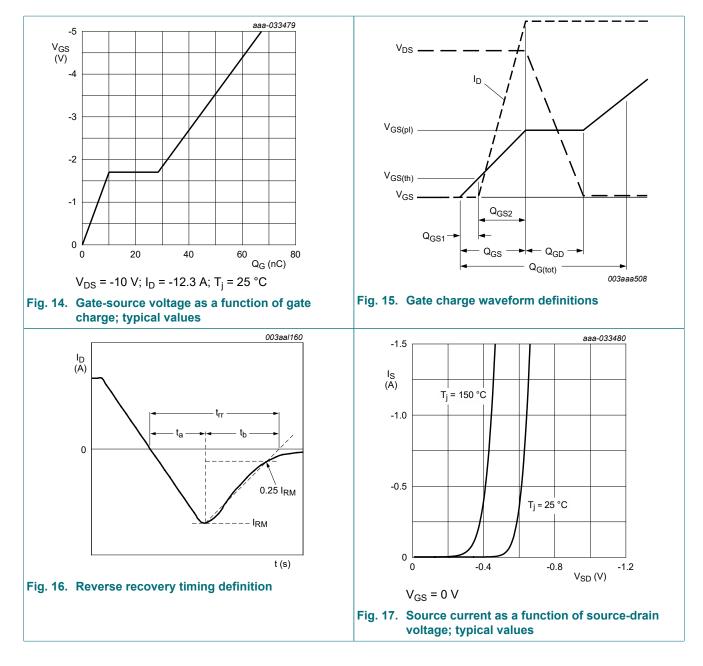
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#### 20 V, P-channel Trench MOSFET

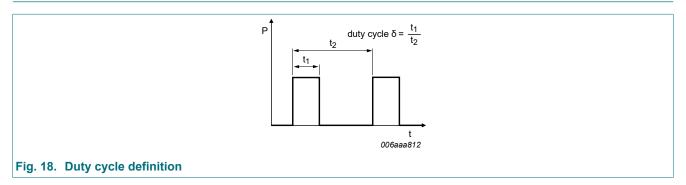


**Product data sheet** 

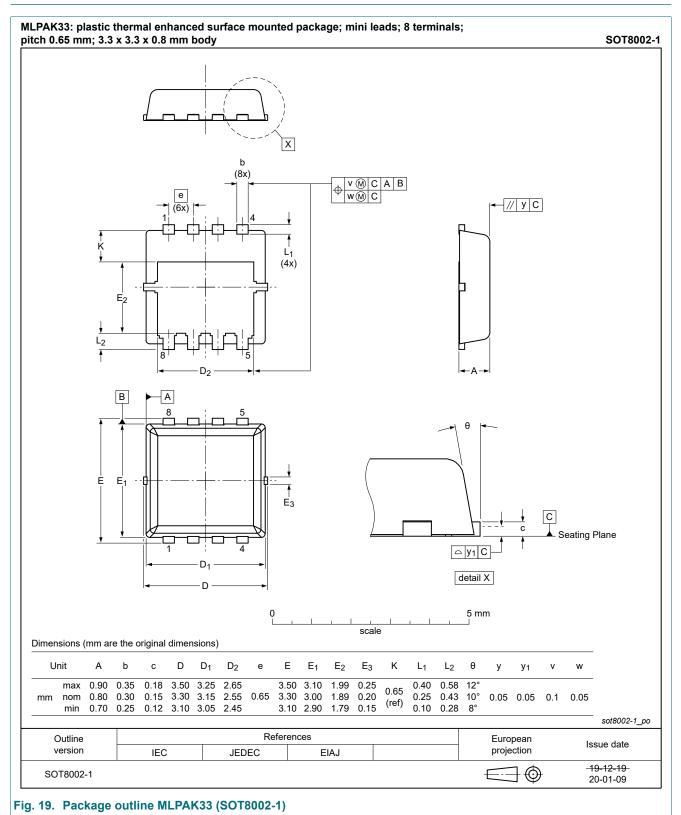
#### 20 V, P-channel Trench MOSFET



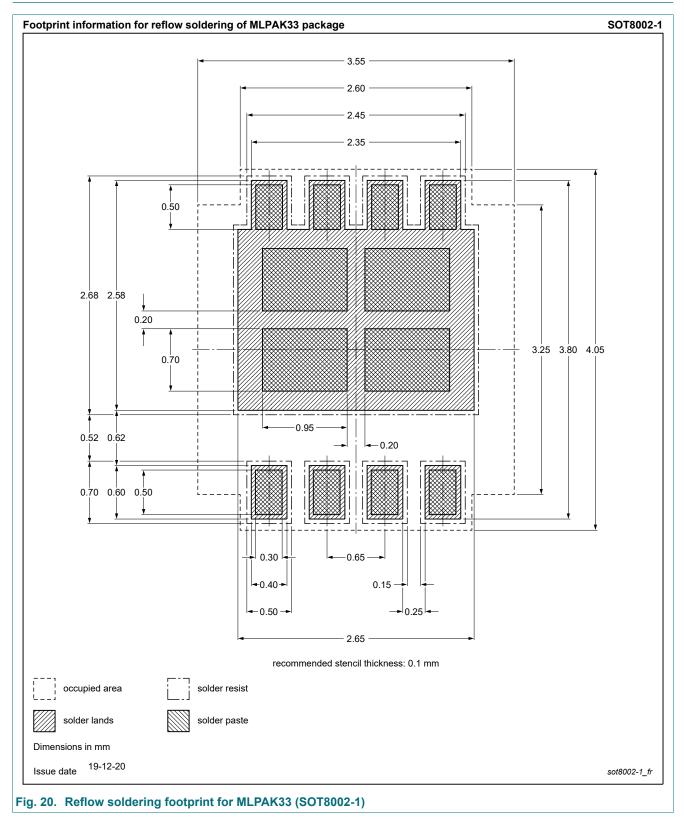
## 11. Test information



## 12. Package outline



## 13. Soldering



# 14. Revision history

Table 8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PXP8R3-20QX v.1	20210906	Product data sheet	-	-		

## 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

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